

Electronic Patent Application Fee Transmittal

Application Number:	10816527			
Filing Date:	01-Apr-2004			
Title of Invention:	High density nanostructured interconnection			
First Named Inventor:	Nagesh R. Basavanhally			
Filer:	Greg H. Parker/Elizabeth Schumacher			
Attorney Docket Number:	33-8-5			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	500	500
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				500